

Vishay Siliconix

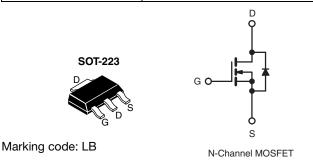
COMPLIANT

HALOGEN

FREE

Power MOSFET

PRODUCT SUMMA	RY	
V _{DS} (V)	100)
$R_{DS(on)}(\Omega)$	V _{GS} = 5.0 V	0.54
Q _g (Max.) (nC)	6.1	
Q _{gs} (nC)	2.6	•
Q _{gd} (nC)	3.3	1
Configuration	Sing	le



FEATURES

- Surface mount
- Available in tape and reel
- Dynamic dV/dt rating
- Repetitive avalanche rated
- Logic-level gate drive
- R_{DS(on)} specified at V_{GS} = 4 V and 5 V
- Fast switching
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance cost-effectiveness.

The SOT-223 package is designed for surface-mounting using vapor phase, infrared, or wave soldering techniques. Its unique package design allows for easy automatic pick-and-place as with other SOT or SOIC packages but has the added advantage of improved thermal performance due to an enlarged tab for heatsinking. Power dissipation of greater than 1.25 W is possible in a typical surface mount application.

ORDERING INFORMATION		
Daakaga	SOT-223	SOT-223
Package	Tube	Tape and Reel
Lead (Pb)-free and Halogen-free	-	SiHLL110TR-GE3
Lead (Pb)-free	IRLL110PbF	IRLL110TRPbF ^a

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (To	_C = 25 °C, un	ess otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V _{DS}	100	V		
Gate-Source Voltage		V_{GS}	± 10	7 v		
Continuous Drain Current	\/ at F 0 \/	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$,	1.5		
Continuous Drain Current	V _{GS} at 5.0 V	T _C = 100 °C	I _D	0.93	A	
Pulsed Drain Current a			I _{DM}	12		
Linear Derating Factor				0.025	W/°C	
Linear Derating Factor (PCB Mount) e				0.017	VV/ C	
Single Pulse Avalanche Energy b			E _{AS}	50	mJ	
Repetitive Avalanche Current ^a			I _{AR}	1.5	Α	
Repetitive Avalanche Energy a			E _{AR}	0.31	mJ	
Maximum Power Dissipation	T _C =	T _C = 25 °C		3.1	W	
Maximum Power Dissipation (PCB Mount) e	T _A =	T _A = 25 °C		2.0	- vv	
Peak Diode Recovery dV/dt ^c	ık Diode Recovery dV/dt c		dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Ran	unction and Storage Temperature Range T _J , T _{stg} -55 to +150		°C			
Soldering Recommendations (Peak Temperature)	d for	10 s	-	300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD}=25$ V, starting $T_J=25$ °C, L=25 mH, $R_g=25$ Ω , $I_{AS}=1.5$ A (see fig. 12). c. $I_{SD}\leq 5.6$ A, $dI/dt\leq 75$ A/µs, $V_{DD}\leq V_{DS}$, $T_J\leq 150$ °C. d. 1.6 mm from case.

- When mounted on 1" square PCB (FR-4 or G-10 material).



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THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	60	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	40	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.12	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	1.0	-	2.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 10 V	-	-	± 100	nA
Zava Cata Valtaga Dvain Couvent		V _{DS} =	: 100 V, V _{GS} = 0 V	-	-	25	μА
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 80 \text{ V}$	V _{GS} = 0 V, T _J = 125 °C	-	-	250	
Due in Course On Otata Basistana	Б	V _{GS} = 5.0 V	$I_D = 0.90 \text{ A}^b$	-	-	0.54	0
Drain-Source On-State Resistance	$R_{DS(on)}$	V _{GS} = 4.0 V	$I_D = 0.75 A$	-	-	0.76	Ω
Forward Transconductance	g _{fs}	V _{DS} =	25 V, I _D = 0.90 A	0.57	-	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		250	-	
Output Capacitance	Coss				80	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	-	15	-	
Total Gate Charge	Qg			-	-	6.1	
Gate-Source Charge	Q _{gs}	$V_{GS} = 5.0 \text{ V}$	$I_D = 5.6 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 ^b	-	-	2.6	nC
Gate-Drain Charge	Q _{gd}		see lig. o and 15	-	-	3.3	
Turn-On Delay Time	t _{d(on)}			-	9.3	-	
Rise Time	t _r	V _{DD} =	= 50 V, I _D = 5.6 A,	-	47	-	1
Turn-Off Delay Time	t _{d(off)}		12 Ω , $R_D = 8.4 \Omega$	-	16	-	ns
Fall Time	t _f]		-	18	-	1
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from		ml I			
Internal Source Inductance	L _S	die contact	package and center of die contact		6.0	-	1 IIH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	showing the	MOSFET symbol showing the		-	1.5	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	12	A
Body Diode Voltage	V _{SD}	T _J = 25 °C	, I _S = 1.5 A, V _{GS} = 0 V ^b	-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 00 1	E C A -11/-14 - 400 A / h	-	110	130	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_J = 25 \text{ °C, } I_F$	= 5.6 A, dI/dt = 100 A/µs ^b	-	0.50	0.65	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	6 mm (0.25") from package and center of die contact - 4.0 - nH MOSFET symbol showing the integral reverse p - n junction diode T _J = 25 °C, I _S = 1.5 A, V _{GS} = 0 V ^b - 2.5 V T _J = 25 °C, I _E = 5.6 A, dl/dt = 100 A/us ^b - 110 130 ns				

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

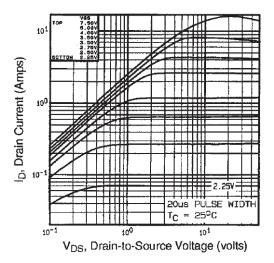


Fig. 1 - Typical Output Characteristics

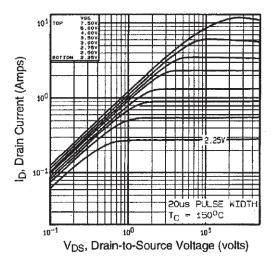


Fig. 2 - Typical Output Characteristics

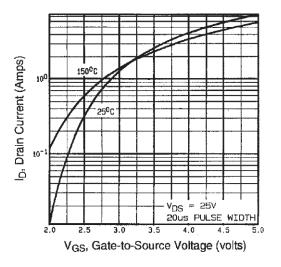


Fig. 3 - Typical Transfer Characteristics

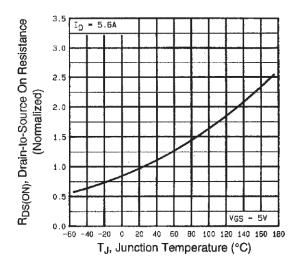


Fig. 4 - Normalized On-Resistance vs. Temperature



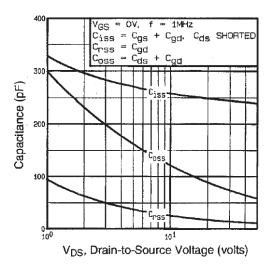


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

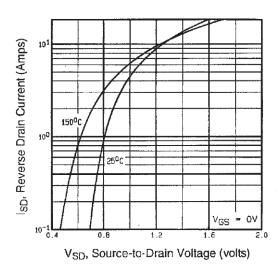


Fig. 7 - Typical Source-Drain Diode Forward Voltage

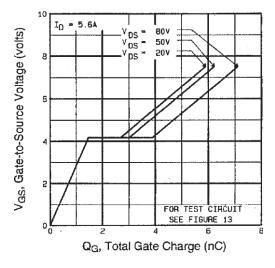


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

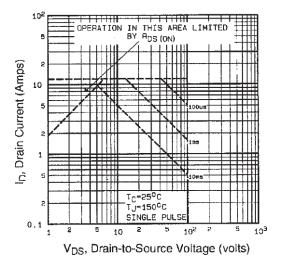


Fig. 8 - Maximum Safe Operating Area



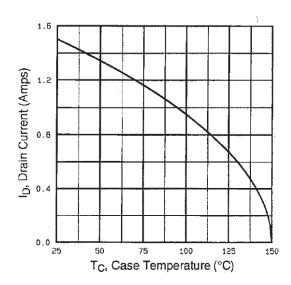


Fig. 9 - Maximum Drain Current vs. Case Temperature

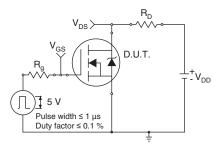


Fig. 10a - Switching Time Test Circuit

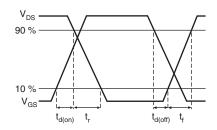


Fig. 10b - Switching Time Waveforms

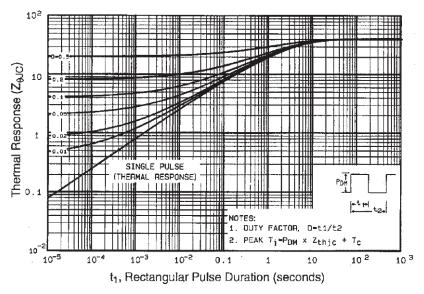


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



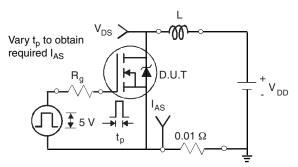


Fig. 12a - Unclamped Inductive Test Circuit

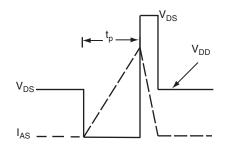


Fig. 12b - Unclamped Inductive Waveforms

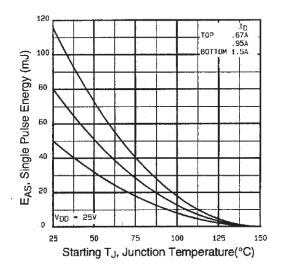


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

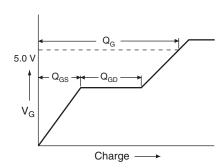


Fig. 13a - Basic Gate Charge Waveform

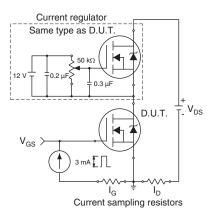
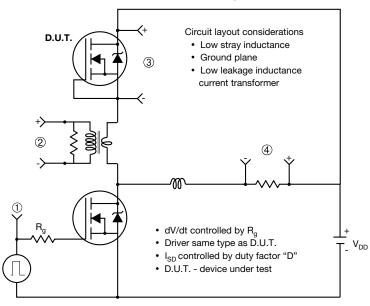


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



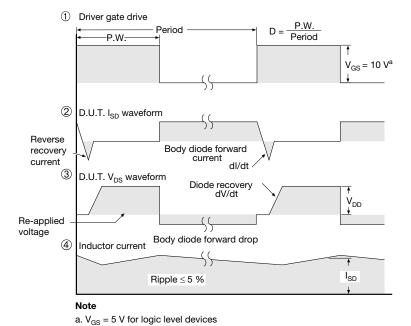


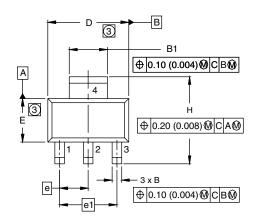
Fig. 14 - For N-Channel

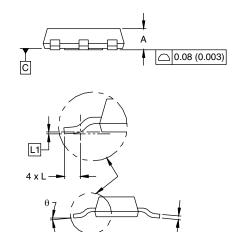
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SOT-223 (HIGH VOLTAGE)





DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
Α	1.55	1.80	0.061	0.071
В	0.65	0.85	0.026	0.033
B1	2.95	3.15	0.116	0.124
С	0.25	0.35	0.010	0.014
D	6.30	6.70	0.248	0.264
E	3.30	3.70	0.130	0.146
е	2.30	2.30 BSC		BSC
e1	4.60	O BSC	0.181	BSC
Н	6.71	7.29	0.264	0.287
L	0.91	-	0.036	=
L1	0.061 BSC		0.0024	BSC
θ	-	10'	-	10'

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.



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